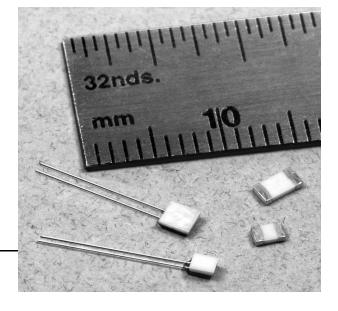
## Honeywell

# **700 Series Platinum RTDs**

## Temperature Sensors



#### **DESCRIPTION**

The 700 Series Platinum RTD (Resistance Temperature Detector) is an economical, miniature temperature sensor. The series is available in two different package configurations, leaded and SMT (Surface Mount Technology). Two sizes are available for each configuration, with the SMT available in industry standard 0805 and 1206 packages.

The 700 Series has 100  $\Omega$  and 1000  $\Omega$  base resistances and is available in both the 3750 ppm/K and 3850 ppm/K temperature coefficients (375 and 385 alphas). The tolerances of the 700 Series meet DIN class A, DIN class B and DIN class 2B industry-standards.

The 700 Series is RoHS (Restriction of Hazardous Substances) compliant (EU Directive 2002/95/EC).

#### **FEATURES**

- Linear resistance vs temperature
- High accuracy
- Interchangeable
- Excellent stability
- · Fast time response
- · Wide temperature range
- RoHS compliant

#### **TYPICAL APPLICATIONS**

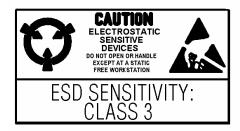
- HVAC (Heating Ventilation and Air Conditioning)
- Electronic assemblies
- Process control
- Appliances
- AutomotiveInstrumentation

## **700 Series Platinum RTDs**

#### **SPECIFICATIONS**

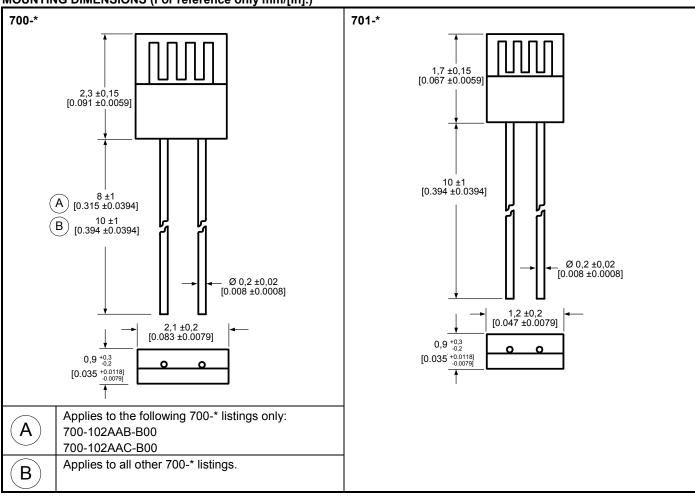
|                   | 700-*   | 701-*   |  |  |
|-------------------|---|---|--|--|
| Temperature       | Class B and 2B: -70 °C to 500 °C (continuous                                  | Class B and 2B: -70 °C to 500 °C (continuous                                  |  |  |
| range             | operation)  | operation)  |  |  |
|                   | Class A: -30 °C to 300 °C   | Class A: -30 °C to 300 °C   |  |  |
| Leads             | Pt-clad Ni wire   | Pt-clad Ni wire   |  |  |
| Long-term         | max. R <sub>0</sub> drift 0.04 % after 1000 h at 500 °C                       | max. R <sub>0</sub> drift 0.04 % after 1000 h at 500 °C                       |  |  |
| stability         |   |   |  |  |
| Vibration         | at least 40 g acceleration at 10 Hz to 2000 Hz,                               | at least 40 g acceleration at 10 Hz to 2000 Hz,                               |  |  |
| resistance        | depends on installation   | depends on installation   |  |  |
| Shock             | at least 100 g acceleration with 8 ms half sine                               | at least 100 g acceleration with 8 ms half sine                               |  |  |
| resistance        | wave, depends on installation   | wave, depends on installation   |  |  |
| Environmental     | unhoused for dry environments only unhoused for dry environments only         |   |  |  |
| conditions        |   |   |  |  |
| Insulation        | >100 MΩ at 20 °C; >2 MΩ at 500 °C   | >100 M $\Omega$ at 20 °C; >2 M $\Omega$ at 500 °C                             |  |  |
| resistance        |   |   |  |  |
| Self heating      | 0.4 K/mW at 0 °C  | 0.6 K/mW at 0 °C  |  |  |
| Response time     | water current (v=0.4 m/s): t <sub>0.5</sub> =0.05 s; t <sub>0.9</sub> =0.15 s | water current (v=0.4 m/s): t <sub>0.5</sub> =0.04 s; t <sub>0.9</sub> =0.12 s |  |  |
|                   | air stream (V=2 m/s): t <sub>0.5</sub> =3.0 s; t <sub>0.9</sub> =10.0 s       | air stream (V=2 m/s): t <sub>0.5</sub> =2.2 s; t <sub>0.9</sub> =7.0 s        |  |  |
| Measuring current | 100 Ω: 0.3 mA to 1.0 mA   | 100 Ω: 0.3 mA to 1.0 mA   |  |  |
|                   | 1000 Ω: 0.1 mA to 0.3 mA  | 1000 Ω: 0.1 mA to 0.3 mA  |  |  |
| Packaging         | anti-static plastic bag   | anti-static plastic bag   |  |  |

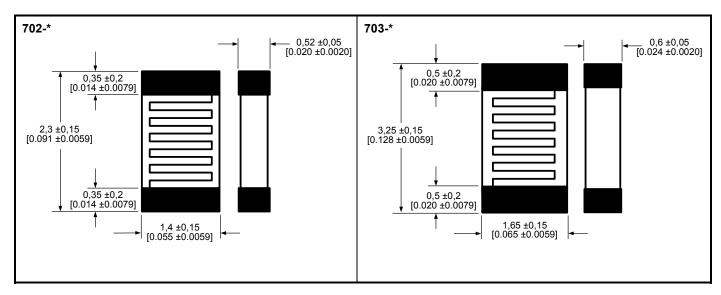
|                   | 702-*   | 703-*   |  |  |
|-------------------|---|---|--|--|
| Temperature       | Class B: -50 °C to 130 °C (continuous operation)                              | Class B: -50 °C to 130 °C (continuous operation)                              |  |  |
| range             |   |   |  |  |
| Soldering         | end-termination galvanic tin-plated with Ni barrier                           | end-termination galvanic tin-plated with Ni barrier                           |  |  |
| connection        | layer   | layer   |  |  |
| Long-term         | max. R₀ drift 0.06 % after 1000 h at 130 °C                                   | max. R <sub>0</sub> drift 0.06 % after 1000 h at 130 °C                       |  |  |
| stability         |   |   |  |  |
| Environmental     | unhoused for dry environments only  | unhoused for dry environments only  |  |  |
| conditions        |   |   |  |  |
| Insulation        | >100 MΩ at 20 °C; >2 MΩ at 130 °C (glass                                      | >100 M $\Omega$ at 20 °C; >2 M $\Omega$ at 130 °C (glass                      |  |  |
| resistance        | covering)   | covering)   |  |  |
| Self heating      | 0.8 K/mW at 0 °C  | 0.4 K/mW at 0 °C  |  |  |
| Response time     | water current (v=0.4 m/s): t <sub>0.5</sub> =0.10 s; t <sub>0.9</sub> =0.25 s | water current (v=0.4 m/s): t <sub>0.5</sub> =0.15 s; t <sub>0.9</sub> =0.30 s |  |  |
|                   | air stream (V = 2 m/s): $t_{0.5}$ =2.5 s; $t_{0.9}$ =8.0 s                    | air stream (V = 2 m/s): $t_{0.5}$ =3.5 s; $t_{0.9}$ =10.0 s                   |  |  |
| Measuring current | 100 Ω: 0.3 mA to 1.0 mA   | 100 Ω: 0.3 mA to 1.0 mA   |  |  |
|                   | 1000 Ω: 0.1 mA to 0.3 mA  | 1000 Ω: 0.1 mA to 0.3 mA  |  |  |
| Processing        | face up mounting: reflow soldering or wave                                    | face up mounting: reflow soldering or wave                                    |  |  |
| instructions      | soldering, e.g. double wave ≤8 s/235 °C                                       | soldering, e.g. double wave ≤8 s/235 °C                                       |  |  |
| Packaging         | face-up in blister reel   | face-up in blister reel   |  |  |



## **Temperature Sensors**

MOUNTING DIMENSIONS (For reference only mm/[in].)





#### **ORDER GUIDE**

| Catalog Listing | Package Style and Size<br>mm [in]   | Nominal<br>Resistance | Temp.<br>Coefficient |            | Tolerance                  | Termination                    |
|-----------------|-------------------------------------|-----------------------|----------------------|------------|----------------------------|--------------------------------|
|                 |                                     | @ 0 °C                |                      | (°C)       |                            |                                |
| 700-101BAA-B00  | Chip, 2,1 w x 2,3 l x 0,9 thk       | 100 Ω                 | 3850 ppm/K           | -70 to 500 | DIN EN 60751, class A      | Bare Pt-clad Ni wire, adjacent |
|                 | [0.083 w x 0.091 l x 0.035 thk]     |                       |                      |            | (R <sub>0</sub> : ±0.06 %) | leads                          |
| 700-101BAB-B00  | Chip, 2,1 w x 2,3 l x 0,9 thk       | 100 Ω                 | 3850 ppm/K           | -70 to 500 | DIN EN 60751, class B      | Bare Pt-clad Ni wire, adjacent |
|                 | [0.083 w x 0.091 l x 0.035 thk]     |                       |                      |            | (R <sub>0</sub> : ±0.12 %) | leads                          |
| 700-102AAB-B00  | Chip, 2,1 w x 2,3 l x 0,9 thk       | $1000\Omega$          | 3750 ppm/K           | -70 to 500 | DIN EN 60751, class B      | Bare Pt-clad Ni wire, adjacent |
|                 | [0.083 w x 0.091 l x 0.035 thk]     |                       |                      |            | (R <sub>0</sub> : ±0.12 %) | leads                          |
| 700-102AAC-B00  | Chip, 2,1 w x 2,3 l x 0,9 thk       | 1000 Ω                | 3750 ppm/K           | -70 to 500 | DIN EN 60751, class 2B     | Bare Pt-clad Ni wire, adjacent |
|                 | [0.083 w x 0.091 l x 0.035 thk]     |                       |                      |            | (R <sub>0</sub> : ±0.24 %) | leads                          |
| 700-102BAA-B00  | Chip, 2,1 w x 2,3 l x 0,9 thk       | 1000 Ω                | 3850 ppm/K           | -70 to 500 | DIN EN 60751, class A      | Bare Pt-clad Ni wire, adjacent |
|                 | [0.083 w x 0.091 l x 0.035 thk]     |                       |                      |            | (R <sub>0</sub> : ±0.06 %) | leads                          |
| 700-102BAB-B00  | Chip, 2,1 w x 2,3 l x 0,9 thk       | 1000 Ω                | 3850 ppm/K           | -70 to 500 | DIN EN 60751, class B      | Bare Pt-clad Ni wire, adjacent |
|                 | [0.083 w x 0.091 l x 0.035 thk]     |                       |                      |            | (R <sub>0</sub> : ±0.12 %) | leads                          |
| 701-101BAA-B00  | Chip, 1,2 w x 1,7 l x 0,9 thk       | 100 Ω                 | 3850 ppm/K           | -70 to 500 | DIN EN 60751, class A      | Bare Pt-clad Ni wire, adjacent |
|                 | [0.047 w x 0.067 l x 0.035 thk]     |                       |                      |            | (R <sub>0</sub> : ±0.06 %) | leads                          |
| 701-101BAB-B00  | Chip, 1,2 w x 1,7 l x 0,9 thk       | 100 Ω                 | 3850 ppm/K           | -70 to 500 | DIN EN 60751, class B      | Bare Pt-clad Ni wire, adjacent |
|                 | [0.047 w x 0.067 l x 0.035 thk]     |                       |                      |            | (R <sub>0</sub> : ±0.12 %) | leads                          |
| 701-102BAB-B00  | Chip, 1,2 w x 1,7 l x 0,9 thk       | 1000 Ω                | 3850 ppm/K           | -70 to 500 | DIN EN 60751, class B      | Bare Pt-clad Ni wire, adjacent |
|                 | [0.047 w x 0.067 l x 0.035 thk]     |                       |                      |            | (R <sub>0</sub> : ±0.12 %) | leads                          |
| 702-101BBB-A00  | SMD 0805, 1,4 w x 2,3 l x 0,52 thk  | 100 Ω                 | 3850 ppm/K           | -50 to 130 | DIN EN 60751, class B      | End termination, galvanic Sn-  |
|                 | [0.055 w x 0.091 l x 0.020]         |                       |                      |            | (R <sub>0</sub> : ±0.12 %) | plated with Ni barrier layer   |
| 702-102BBB-A00  | SMD 0805, 1,4 w x 2,3 l x 0,52 thk  | 1000 Ω                | 3850 ppm/K           | -50 to 130 | DIN EN 60751, class B      | End termination, galvanic Sn-  |
|                 | [0.055 w x 0.091 l x 0.020]         |                       |                      |            | (R <sub>0</sub> : ±0.12 %) | plated with Ni barrier layer   |
| 703-101BBB-A00  | SMD 1206, 1,65 w x 3,25 l x 0,6 thk | 100 Ω                 | 3850 ppm/K           | -50 to 130 | DIN EN 60751, class B      | End termination, galvanic Sn-  |
|                 | [0.065 w x 0.128 l x 0.024]         |                       |                      |            | (R <sub>0</sub> : ±0.12 %) | plated with Ni barrier layer   |
| 703-102BBB-A00  | SMD 1206, 1,65 w x 3,25 l x 0,6 thk | 1000 Ω                | 3850 ppm/K           | -50 to 130 | DIN EN 60751, class B      | End termination, galvanic Sn-  |
|                 | [0.065 w x 0.128 l x 0.024]         |                       |                      |            | (R <sub>0</sub> : ±0.12 %) | plated with Ni barrier layer   |

### **WARNING**

#### **PERSONAL INJURY**

DO NOT USE these products as safety or emergency stop devices or in any other application where failure of the product could result in personal injury.

Failure to comply with these instructions could result in death or serious injury.

#### WARRANTY/REMEDY

Honeywell warrants goods of its manufacture as being free of defective materials and faulty workmanship. Honeywell's standard product warranty applies unless agreed to otherwise by Honeywell in writing; please refer to your order acknowledgement or consult your local sales office for specific warranty details. If warranted goods are returned to Honeywell during the period of coverage, Honeywell will repair or replace, at its option, without charge those items it finds defective. The foregoing is buyer's sole remedy and is in lieu of all other warranties, expressed or implied, including those of merchantability and fitness for a particular purpose. In no event shall Honeywell be liable for consequential, special, or indirect damages.

While we provide application assistance personally, through our literature and the Honeywell web site, it is up to the customer to determine the suitability of the product in the application.

Specifications may change without notice. The information we supply is believed to be accurate and reliable as of this printing. However, we assume no responsibility for its use.



#### MISUSE OF DOCUMENTATION

- The information presented in this product sheet is for reference only. Do not use this document as a product installation guide.
- Complete installation, operation, and maintenance information is provided in the instructions supplied with each product.

Failure to comply with these instructions could result in death or serious injury.

#### **SALES AND SERVICE**

Honeywell serves its customers through a worldwide network of sales offices, representatives and distributors. For application assistance, current specifications, pricing or name of the nearest Authorized Distributor, contact your local sales office or:

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